## NTST30120CT, NTSJ30120CTG, NTSB30120CT-1G, NTSB30120CTG, NTSB30120CTT4G

## Very Low Forward Voltage Trench-based Schottky Rectifier

## Exceptionally Low $\mathrm{V}_{\mathrm{F}}=0.50 \mathrm{~V}$ at $\mathrm{I}_{\mathrm{F}}=5 \mathrm{~A}$

## Features

- Fine Lithography Trench-based Schottky Technology for Very Low Forward Voltage and Low Leakage
- Fast Switching with Exceptional Temperature Stability
- Low Power Loss and Lower Operating Temperature
- Higher Efficiency for Achieving Regulatory Compliance
- Low Thermal Resistance
- High Surge Capability
- These are $\mathrm{Pb}-$ Free Devices


## Typical Applications

- Switching Power Supplies including Notebook / Netbook Adapters, ATX and Flat Panel Display
- High Frequency and DC-DC Converters
- Freewheeling and OR-ing diodes
- Reverse Battery Protection
- Instrumentation


## Mechanical Characteristics

- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94-0 @ 0.125 in
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: $260^{\circ} \mathrm{C}$ Maximum for 10 sec


ON Semiconductor ${ }^{\circledR}$
www.onsemi.com

VERY LOW FORWARD VOLT-
AGE, LOW LEAKAGE SCHOTTKY BARRIER
RECTIFIERS 30 AMPERES, 120 VOLTS

PIN CONNECTIONS


D2PAK CASE 418B

ORDERING INFORMATION
See detailed ordering and shipping information on page 5 of this data sheet.

## NTST30120CT, NTSJ30120CTG, NTSB30120CT-1G, NTSB30120CTG, NTSB30120CTT4G

MAXIMUM RATINGS

| Rating |  | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage |  | $V_{\text {RRM }}$ <br> $V_{\text {RWM }}$ $V_{R}$ | 120 | V |
| Average Rectified Forward Current (Rated $\mathrm{V}_{\mathrm{R}}, \mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}$ ) | Per device Per diode | $\mathrm{I}_{\mathrm{F}(\mathrm{AV})}$ | $\begin{aligned} & 30 \\ & 15 \end{aligned}$ | A |
| Peak Repetitive Forward Current (Rated $\mathrm{V}_{\mathrm{R}}$, Square Wave, $20 \mathrm{kHz}, \mathrm{T}_{\mathrm{C}}=130^{\circ} \mathrm{C}$ ) | Per device Per diode | IfRM | $\begin{aligned} & 60 \\ & 30 \end{aligned}$ | A |
| Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz ) |  | $\mathrm{I}_{\text {FSM }}$ | 150 | A |
| Operating Junction Temperature |  | TJ | -40 to +150 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature |  | $\mathrm{T}_{\text {stg }}$ | -40 to +150 | ${ }^{\circ} \mathrm{C}$ |
| Voltage Rate of Change (Rated $\mathrm{V}_{\mathrm{R}}$ ) |  | dv/dt | 10,000 | V/us |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

| Rating | Symbol | NTST30120CTG <br> NTSB30120CT-1G | NTSB30120CTG | NTSJ30120CTG | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Maximum Thermal Resistance per Diode |  |  |  |  |  |
| Junction-to-Case <br> Junction-to-Ambient | $R_{\theta J C}$ | $R_{\theta J A}$ | 2.5 |  |  |

ELECTRICAL CHARACTERISTICS (Per Leg unless otherwise noted)

| Rating | Symbol | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Maximum Instantaneous Forward Voltage (Note 1) $\begin{aligned} & \left(I_{F}=5 \mathrm{~A}, \mathrm{~T}_{J}=25^{\circ} \mathrm{C}\right) \\ & \left(I_{F}=7.5 \mathrm{~A}, \mathrm{~T}_{J}=25^{\circ} \mathrm{C}\right) \\ & \left(I_{F}=15 \mathrm{~A}, \mathrm{~T}_{J}=25^{\circ} \mathrm{C}\right) \\ & \left(I_{F}=5 \mathrm{~A}, \mathrm{~T}_{J}=125^{\circ} \mathrm{C}\right) \\ & \left(I_{F}=7.5 \mathrm{~A}, \mathrm{~T}_{J}=125^{\circ} \mathrm{C}\right) \\ & \left(I_{F}=15 \mathrm{~A}, \mathrm{~T}_{J}=125^{\circ} \mathrm{C}\right) \end{aligned}$ | $\mathrm{v}_{\mathrm{F}}$ | $\begin{aligned} & 0.56 \\ & 0.71 \\ & 0.90 \\ & 0.50 \\ & 0.60 \\ & 0.68 \end{aligned}$ | $\begin{gathered} - \\ \overline{-} \\ 1.08 \\ - \\ - \\ 0.76 \end{gathered}$ | V |
| Maximum Instantaneous Reverse Current (Note 1) $\begin{aligned} & \left(V_{R}=90 \mathrm{~V}, \mathrm{~T}_{J}=25^{\circ} \mathrm{C}\right) \\ & \left(\mathrm{V}_{\mathrm{R}}=90 \mathrm{~V}, \mathrm{~T}_{J}=125^{\circ} \mathrm{C}\right) \end{aligned}$ <br> (Rated dc Voltage, $\mathrm{T}_{J}=25^{\circ} \mathrm{C}$ ) <br> (Rated dc Voltage, $\mathrm{T}_{\mathrm{J}}=125^{\circ} \mathrm{C}$ ) | $\mathrm{I}_{\mathrm{R}}$ | $\begin{aligned} & 16 \\ & 11 \\ & - \\ & 25 \end{aligned}$ | $\begin{aligned} & 800 \\ & 100 \end{aligned}$ | $\mu \mathrm{A}$ <br> mA <br> $\mu \mathrm{A}$ <br> mA |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse Test: Pulse Width $=300 \mu \mathrm{~s}$, Duty Cycle $\leq 2.0 \%$

## NTST30120CT, NTSJ30120CTG, NTSB30120CT-1G, NTSB30120CTG, NTSB30120CTT4G <br> TYPICAL CHARACTERISITICS



Figure 1. Typical Instantaneous Forward Characteristics

$\mathrm{V}_{\mathrm{R}}$, REVERSE VOLTAGE (V)
Figure 3. Typical Junction Capacitance

Figure 2. Typical Reverse Current Characteristics


Figure 4. Current Derating per Leg


Figure 5. Current Derating


Figure 6. Forward Power Dissipation

## NTST30120CT, NTSJ30120CTG, NTSB30120CT-1G, NTSB30120CTG, NTSB30120CTT4G <br> TYPICAL CHARACTERISITICS



Figure 7. Typical Transient Thermal Response for NTST30120CT and NTSB30120CT-1G

t, Pulse Time (sec)
Figure 8. Typical Transient Thermal Response for NTSJ30120CTG


Figure 9. Typical Transient Thermal Response for NTSB30120CTG

## NTST30120CT, NTSJ30120CTG, NTSB30120CT-1G, NTSB30120CTG, NTSB30120CTT4G

ORDERING INFORMATION

| Device | Package | Shipping $^{\dagger}$ |
| :--- | :---: | :---: |
| NTST30120CTG | TO-220AB <br> (Pb-Free) | 50 Units / Rail |
| NTSJ30120CTG | TO-220FP <br> (Halide-Free) | 50 Units / Rail |
| NTSB30120CT-1G | IPAK <br> (Pb-Free) | 50 Units / Rail |
| NTSB30120CTG | DPPAK <br> (Pb-Free) | 50 Units / Rail |
| NTSB30120CTT4G | D2PAK <br> (Pb-Free) | 800 / Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## MARKING DIAGRAMS



TO-220AB


TO-220FP


I2PAK


D²PAK

A = Assembly Location
Y = Year
WW = Work Week
AKA = Polarity Designator
$x \quad=\mathrm{G}$ or H
$\mathrm{G} \quad=\mathrm{Pb}-$ Free Package
H = Halide-Free Package


DATE 13 JAN 2022
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 2009.
2. CONTROLLING DIMENSION: INCHES
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.
4. MAX WIDTH FOR F102 DEVICE $=1.35 \mathrm{MM}$

| DIM | INCHES |  | MILLIMETERS |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN. | MAX. | MIN. | MAX. |
| A | 0.570 | 0.620 | 14.48 | 15.75 |
| B | 0.380 | 0.415 | 9.66 | 10.53 |
| C | 0.160 | 0.190 | 4.07 | 4.83 |
| D | 0.025 | 0.038 | 0.64 | 0.96 |
| F | 0.142 | 0.161 | 3.60 | 4.09 |
| G | 0.095 | 0.105 | 2.42 | 2.66 |
| H | 0.110 | 0.161 | 2.80 | 4.10 |
| J | 0.014 | 0.024 | 0.36 | 0.61 |
| K | 0.500 | 0.562 | 12.70 | 14.27 |
| L | 0.045 | 0.060 | 1.15 | 1.52 |
| N | 0.190 | 0.210 | 4.83 | 5.33 |
| Q | 0.100 | 0.120 | 2.54 | 3.04 |
| R | 0.080 | 0.110 | 2.04 | 2.79 |
| S | 0.045 | 0.055 | 1.15 | 1.41 |
| T | 0.235 | 0.255 | 5.97 | 6.47 |
| U | 0.000 | 0.050 | 0.00 | 1.27 |
| V | 0.045 | ---- | 1.15 | --- |
| Z | ---- | 0.080 | --- | 2.04 |


| STYLE 1: |  |
| ---: | :--- |
| PIN 1. | BASE |
| 2. | COLLECTOR |
| 3. | EMITTER |
| 4. | COLLECTOR |
|  |  |
| STYLE 5: |  |
| PIN 1. | GATE |
| 2. | DRAIN |
| 3. | SOURCE |
| 4. | DRAIN |
|  |  |
| STYLE 9: |  |
| PIN 1. | GATE |
| 2. | COLLECTOR |
| 3. | EMITTER |
| 4. | COLLECTOR |


| STYLE 2: |  |
| ---: | :--- |
| PIN 1. | BASE |
| 2. | EMITTER |
| 3. | COLLECTOR |
| 4. | EMITTER |
|  |  |
| STYLE 6: |  |
| PIN 1. | ANODE |
| 2. | CATHODE |
| 3. | ANODE |
| 4. | CATHODE |
| STYLE 10: |  |
| PIN 1. | GATE |
| 2. | SOURCE |
| 3. | DRAIN |
| 4. | SOURCE |


| STYLE 3: |  |
| ---: | :--- |
| PIN 1. | CATHODE |
| 2. | ANODE |
| 3. | GATE |
| 4. | ANODE |
|  |  |
| STYLE 7: |  |
| PIN 1. | CATHODE |
| 2. | ANODE |
| 3. | CATHODE |
| 4. | ANODE |
|  |  |
| STYLE 11: |  |
| PIN 1. | DRAIN |
| 2. | SOURCE |
| 3. | GATE |
| 4. | SOURCE |

STYLE 4:
PIN 1. MAIN TERMINAL 1
2. MAIN TERMINAL 2
3. GATE
4. MAIN TERMINAL 2

STYLE $8:$
PIN 1. CATHODE
2. ANODE
3. EXTERNAL TRIP/DELAY
4. ANODE

STYLE 12:
PIN 1. MAIN TERMINAL 1
2. MAIN TERMINAL 2
3. GATE
3. GATE 4. NOT CONNECTED

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SCALE 1:1


STYLE 1:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
3. EMITIER

STYLE 2:
PIN 1. GATE
2. DRAIN 3. SOURCE
4. DRAIN

STYLE 3:
PIN 1. ANODE
2. CATHODE
3. ANODE
3. ANODE

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH

| DIM | INCHES |  | MILLIMETERS |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |
| A | 0.335 | 0.380 | 8.51 | 9.65 |
| B | 0.380 | 0.406 | 9.65 | 10.31 |
| C | 0.160 | 0.185 | 4.06 | 4.70 |
| D | 0.026 | 0.035 | 0.66 | 0.89 |
| E | 0.045 | 0.055 | 1.14 | 1.40 |
| F | 0.122 REF |  | 3.10 REF |  |
| G | 0.100 BSC |  | 2.54 BSC |  |
| H | 0.094 | 0.110 | 2.39 | 2.79 |
| J | 0.013 | 0.025 | 0.33 | 0.64 |
| K | 0.500 | 0.562 | 12.70 | 14.27 |
| S | 0.390 REF |  | 9.90 REF |  |
| V | 0.045 | 0.070 | 1.14 | 1.78 |
| W | 0.522 | 0.551 | 13.25 | 14.00 |

STYLE 4:
PIN 1. GATE
2. COLLECTOR
3. EMITTER
3. EMITTER

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## SCALE 1:1



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982
CONTROLLING DIMENSION: INCH.
2. 418B-01 THRU 418B-03 OBSOLETE, NEW STANDARD 418B-04.

|  | INCHES |  | MILLIMETERS |  |
| :---: | :---: | :---: | :---: | :---: |
| DIM | MIN | MAX | MIN | MAX |
| A | 0.340 | 0.380 | 8.64 | 9.65 |
| B | 0.380 | 0.405 | 9.65 | 10.29 |
| C | 0.160 | 0.190 | 4.06 | 4.83 |
| D | 0.000 | 0.035 | 0.51 | 0.89 |
| E | 0.045 | 0.055 | 1.14 | 1.40 |
| F | 0.310 | 0.350 | 7.87 | 8.89 |
| G | 0.100 | BSC | 2.54 |  |
| BSC |  |  |  |  |
| H | 0.080 | 0.110 | 2.03 | 2.79 |
| J | 0.018 | 0.025 | 0.46 | 0.64 |
| K | 0.090 | 0.110 | 2.29 | 2.79 |
| L | 0.052 | 0.072 | 1.32 | 1.83 |
| M | 0.280 | 0.320 | 7.11 | 8.13 |
| N | 0.197 | REF | 5.00 REF |  |
| P | 0.079 | REF | 2.00 REF |  |
| R | 0.039 |  | REF | 0.99 |
| REF | 0.55 | 0.625 | 14.60 | 15.88 |
| V | 0.045 | 0.055 | 1.14 | 1.40 |

VARIABLE

VIEW W-W
${ }_{2}^{\text {VIEW W-W }}$
VIEW W-W
3

| STYLE 1: | STYLE 2: | STYLE 3: | STYLE 4: | STYLE 5: | SIN 1. CATHODE |
| :---: | :---: | :---: | :---: | :---: | :---: |
| PIN 1. BASE | PIN 1. GATE | PIN 1. ANODE | PIN 1. GATE | NO CONNECT |  |
| 2. COLLECTOR | 2. DRAIN | 2. CATHODE | 2. COLLECTOR | 2. ANODE | 2. CATHODE |
| 3. EMITTER | 3. SOURCE | 3. ANODE | 3. EMITTER | 3. CATHODE | 3. ANODE |
| 4. COLLECTOR | 4. DRAIN | 4. CATHODE | 4. COLLECTOR | 4. ANODE | 4. CATHODE |

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D2PAK 3
CASE 418B-04
ISSUE L
GENERIC

## MARKING DIAGRAM*


*This information is generic. Please refer to device data sheet for actual part marking. $\mathrm{Pb}-$ Free indicator, " G " or microdot " $\mathrm{\nabla}$ ", may or may not be present.

SOLDERING FOOTPRINT*

*For additional information on our $\mathrm{Pb}-$ Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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